

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Gurtej S. Sandhu

**Serial No.:** 09/023,146

**Filed:** February 12, 1998

**For:** TUNGSTEN SILICIDE (WSIX)  
DEPOSITION PROCESS FOR  
SEMICONDUCTOR MANUFACTURE

**Confirmation No.:** 6553

**Examiner:** W. Coleman

**Group Art Unit:** 2823

**Attorney Docket No.:** 2269-3369.1US  
(91-365RE)

**VIA ELECTRONIC FILING**  
**June 25, 2007**

**FEE ADDRESSEE FOR RECEIPT OF PTO NOTICES  
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Sir:

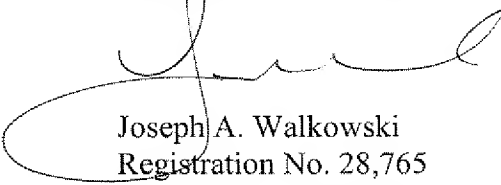
1. This letter is to specify that the FEE ADDRESSEE for this patent is:  

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2. The Customer Number for the Fee Addressee is **26809**.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.

**Serial No. 09/023,146**

4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,

A handwritten signature in black ink, appearing to read 'J. Walkowski', with a large, sweeping loop at the end.

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Date: June 25, 2007  
JAW/dlm:slm

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